

650 V Gen 4 Power Silicon Carbide Schottky Diode, 12 A



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)} 12 A					
V_{R}	650 V				
V _F at I _F at 25 °C, typ.	1.3 V				
T _J max.	175 °C				
I _R at V _R at 175 °C	84 μΑ				
$Q_{C} (V_{R} = 400 V)$	33 nC				
Package	TO-220AC 2L				
Circuit configuration	Single				

FEATURES

Positive V_F temperature coefficient for easy paralleling



Virtually no recovery tail and no switching losses

• Temperature invariant switching behavior

ROHS COMPLIANT HALOGEN FREE

• 175 °C maximum operating junction temperature

• AEC-Q101 qualified meets JESD 201 class 2 whisker test

 Solder bath temperature 275 °C maximum, 10 s per JESD 22-B106

 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

DESCRIPTION / APPLICATIONS

Wide band gap SiC based 650 V Schottky diode, designed for high performance and ruggedness.

Optimized for extreme high-speed hard switching across a wide temperature range. This SiC diode is ideal for applications with high dl/d $_t$ such as high efficiency PFC and ultra-high frequency output rectifiers in AC/DC and DC/DC converters.

MECHANICAL DATA

Case: TO-220AC 2L

Molding compound meets UL 94 V-0 flammability rating Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

Mounting torque: 10 in-lbs maximum

MAXIMUM RATINGS (T _A = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Peak repetitive reverse voltage	V_{RRM}		650	V			
Continuous forward current	I _F ⁽¹⁾	T _C = 145 °C (DC)	12	Α			
Continuous forward current	I _F (2)	$T_C = 139 ^{\circ}C (DC)$	12	Α			
DC blocking voltage	V_{DC}		650	V			
Repetitive peak forward current	I _{FRM}	$T_C = 25$ °C, f = 50 Hz, square wave, DC = 25 %	51				
Non-repetitive peak forward arrange arrange	I _{FSM}	$T_C = 25$ °C, $t_p = 10$ ms, half sine wave	72	Α			
Non-repetitive peak forward surge current		$T_C = 110 ^{\circ}\text{C}$, $t_p = 10 \text{ms}$, half sine wave	57				
	P _{tot} (1)	T _C = 25 °C	91	w			
Dever discipation		T _C = 110 °C	39	7 VV			
Power dissipation	P _{tot} (2)	T _C = 25 °C	75	W			
		T _C = 110 °C	32.5				
124	∫i ² dt	T _C = 25 °C	25.9	A2-			
l ² t value		T _C = 110 °C	16.2	A ² s			
Operating junction and storage temperatures	T _J ⁽²⁾ , T _{Stg}		-55 to +175	°C			

Notes

- (1) Based on typical R_{th}
- (2) Based on maximum R_{th}
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	MBOL TEST CONDITIONS		TYP.	MAX.	UNITS	
		I _F = 12 A	-	1.3	1.5		
Forward voltage	V _F	I _F = 12 A, T _J = 150 °C	-	1.45	1.75	V	
		I _F = 12 A, T _J = 175 °C	-	1.55	-		
	I _R	$V_R = V_R$ rated	-	2.2	80	μА	
Reverse leakage current		V _R = V _R rated, T _J = 150 °C	-	38	190		
		V _R = V _R rated, T _J = 175 °C	-	84	-		
Total capacitance	С	V _R = 1 V, f = 1 MHz	-	549	-	pF	
Total Capacitatice		V _R = 400 V, f = 1 MHz	-	48	-	PΓ	
Total capacitive charge	Q _C	V _R = 400 V, f = 1 MHz	-	33	-	nC	

THERMAL AND MECHANICAL SPECIFICATIONS (T _A = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL TEST CONDITIONS MIN. TYP. MAX. UNITS						
Thermal resistance, junction to case	R _{thJC}		-	1.65	2.0	°C/W	
Marking device	4C12ET07T						

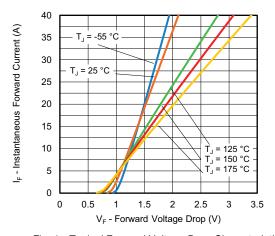


Fig. 1 - Typical Forward Voltage Drop Characteristics

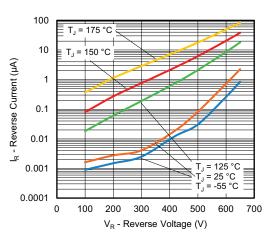


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

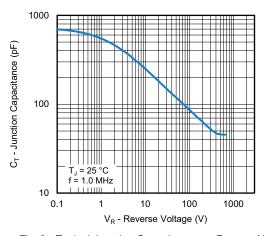


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

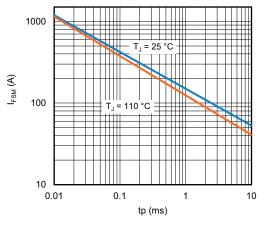


Fig. 4 - Non-Repetitive Peak Forward Surge Current vs. Pulse Duration (Square Wave)

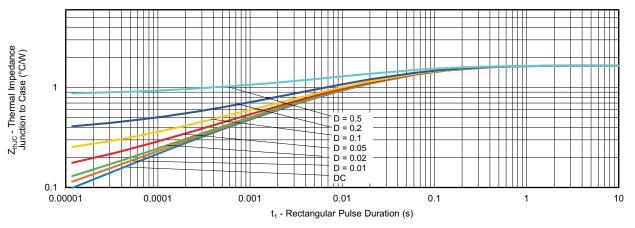


Fig. 5 - Typical Thermal Impedance Z_{thJC} Characteristics

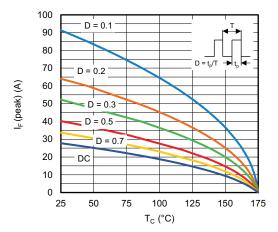


Fig. 6 - Peak Forward Current vs. Maximum Allowable Case Temperature

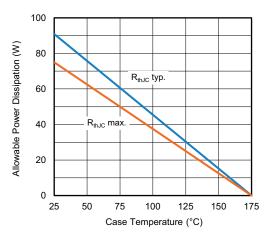


Fig. 7 - Forward Power Loss Characteristics

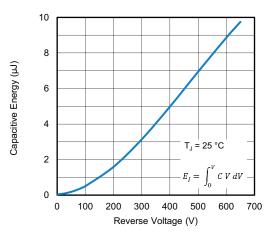


Fig. 8 - Typical Capacitive Energy vs. Reverse Voltage

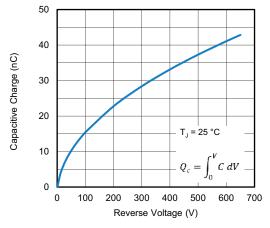
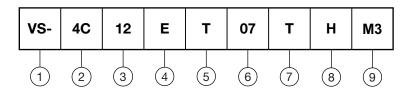


Fig. 9 - Typical Capacitive Charge vs. Reverse Voltage



ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product
- **2** 4C = SiC diode, generation 4
- **3** Current rating (12 = 12 A)
- E = single diode
- **5** T = TO-220 package
- Voltage rating: (07 = 650 V)
- 7 T = true 2 pin
- 8 H = AEC-Q101 qualified
- 9 Environmental digit:

M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

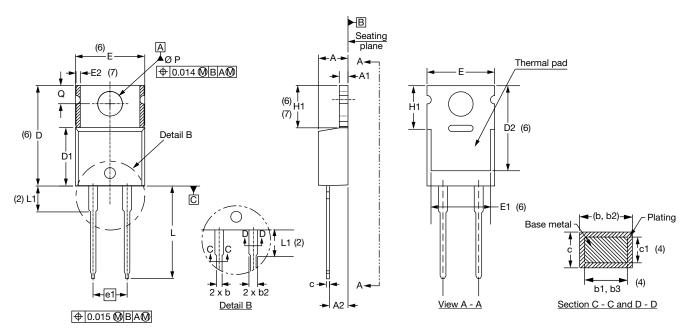
ORDERING INFORMATION						
PREFERRED P/N	UNIT WEIGHT	BASE QUANTITY	PACKAGING DESCRIPTION			
VS-4C12ET07THM3	2 g	50 per tube	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?96069
Part marking information	www.vishay.com/doc?95391



TO-220AC 2L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	NOTES	
STIMBOL	MIN.	MAX.	MIN.	MAX.	NOIES
Α	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
E	10.11	10.51	0.398	0.414	3, 6

SYMBOL	MILLIMETERS		INC	NOTES	
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
E1	6.86	8.89	0.270	0.350	6
E2	ı	0.76	-	0.030	7
e1	4.88	5.28	0.192	0.208	
H1	5.84	6.86	0.230	0.270	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØΡ	3.54	3.73	0.139	0.147	
Ø	2.60	3.00	0.102	0.118	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- $^{(7)}$ Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC® TO-220, except D2, where JEDEC® minimum is 0.480"



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